

Quarterly Reliability Monitoring Results

Quarters: Q1/2022 to Q4/2023

Based on structural similarity

Supplier Nexperia B.V. Name of Laboratory		User Part Number PTVS54VS1UR-Q Part Description													
											Nexperia DHAM	Protection			
									Assembly reliability labs		SMD package				
Based on AEC-Q101 Test		Test Conditions	Duration	# Lots	# Quantity	# Rejects									
	TEST														
	Pre- and Post-Stress														
# E1	Electrical Test	Tamb = 25 °C	N/A	see below	all parts	see below									
		JESD22-A113													
		Bake Tamb = 125 °C	24 hours												
	PC	Soak Tamb = 85 °C, RH = 85%	168 hours			_									
# A1	Preconditioning	Reflow soldering	3 cycles	524	22940	0									
		MIL-STD-750-1													
	HTRB	M1038 Method A													
# D1	Bias	Tj = Tjmax, Vr = 100% of max. datasheet reverse voltage	1000 hauma	205	0400	0									
# B1	Dias	Teverse voltage	1000 hours	205	9400	0									
	тс	JESD22-A104													
# A4	Temperature Cycling	-65 °C to Tjmax, not to exceed 150°C	1000 cycles	156	7080	0									
# A4			1000 Cycles	130	7000	0									
	UHAST	JESD22-A118													
# A3 or	Unbiased HAST	Tamb = 130 °C, RH = 85 %		156	7080	0									
		JESD22-A102	– 96 hours												
	AC	Tamb = 121 °C, RH = 100 %													
# A3 alt	Autoclave	Pressure = 205 kPa (29.7 psia)													
	H3TRB	JESD22-A101													
	High Humidity High	Tamb = 85 °C, RH = 85%, VR = 80 % of													
# A2 alt	Temperature Reverse Bias	rated reverse voltage ^[1]	1000 hours	156	7080	0									
		MIL-STD-750 Method 1037													
	IOL	ton = toff, devices powered to insure ΔTj =													
# A5	Intermittent Operating Life	100 °C for 15000 cycles	1000 hours	n.a.	n.a.	n.a.									
	RSH	JESD22-A111													
# C8	Resistance to Solder Heat	260 °C ± 5 °C	10 s	56	1700	0									
	SD														
# C10	Solderability	J-STD-002		56	1700	0									

^[1] The maximum applied voltage is limited by test chamber set up and does not exceed 115V.

Calculation of FIT and MTTF

Test considered for FIT calculation: High Temperature Reverse Bias (HTRB, Test #B1) Confidence level 60%, derated to 55 °C, activation energy 0.7 eV, test time 168 to 1000 hours

Wafer Fab	Technology	Quantity	Rejects	Failure Rate (FIT)	MTTF (hrs)
Nexperia					
DHAM	Protection	9400	0	0,45	2,21E+09

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